

规格书编号

**SPEC NO:** 

# 产品规格书 SPECIFICATION

CUSTOMER 客 户:										
PRODUCT 产品:	SAW RESONATOR									
MODEL NO 型 号:	HDR390MS3									
PREPARED 编 制:	CHECKED 审 核:									
APPROVED 批准:	DATE 日 其	月: 2016-7-16								
客户确认 CUSTOMER RECEIVED:										
审核 CHECKED	批准 APPROVED	日期 DATE								

## 无锡市好达电子有限公司 Shoulder Electronics Limited



## 更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark



### 1. SCOPE

This specification is applied to a SAW resonator designed for the stabilization of transmitters such as garage door openers and security transmitters.

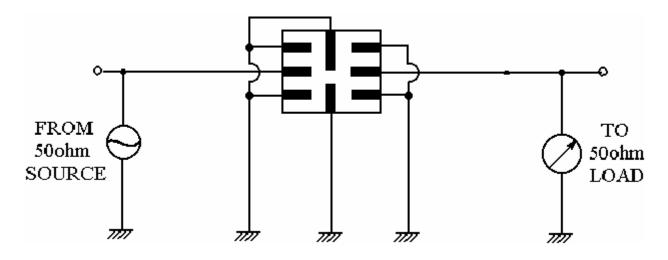
## 2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V
AC Voltage Vpp	10V50Hz/60Hz
Operation temperature	-40°C to +85°C
Storage temperature	-45°C to +85°C
RF Power Dissipation	0dBm

#### 2.2 Electronic Characteristics

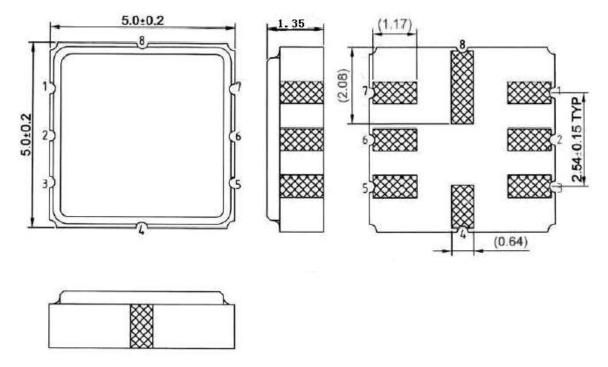
Item		Unites	Minimum	Typical	Maximum
Center Freque	ncy	MHz	389.925	390.000	390.075
Insertion Loss		dB		1.5	2.2
Quality Factor	· Unload Q		8000	13900	
50Ω Loaded	Q		1000	2000	
Temperature	Temperature Turnover Temperature		10	25	40
Stability	Freq.temp.Coefficient	ppm/°C2		0.037	
Frequency Ag	ing	ppm/yr		≤10	
DC. Insulation	Resistance	МΩ	1.0		
DEE : 1	Motional Resistance R1			19	26
RF Equivalen	Motional Inductance L1	μН		111.04	
KLC Wodel	Motional Capacitance C1	fF		1.4998	
Transducer Sta	atic Capacitance	pF		1.72	

### 3. TEST CIRCUIT





#### 4. DIMENSION



- 2.Input
- 6.Output
- 1.3.5.7.Gound
- 4.8 Ground

#### 5. ENVIRONMENTAL CHARACTERISTICS

#### 5-1 High temperature exposure

Subject the device to +85 °C for 16 hours. Then release the resonator into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

#### 5-2 Low temperature exposure

Subject the device to  $-40^{\circ}$ C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

#### 5-3 Temperature cycling

Subject the device to a low temperature of  $-40^{\circ}$ C for 30 minutes. Following by a high temperature of  $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2.2.

#### 5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at  $260^{\circ}$ C  $\pm 10^{\circ}$ C for  $10\pm 1$  sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2.2.

#### 5-5 Solderability

Subject the device terminals into the solder bath at  $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2.2.



#### **SAW RESONATOR**

#### 5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2.2.

#### 5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2.2.

#### 6. REMARK

#### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

#### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

### 7. Packing

#### 7.1 Dimensions

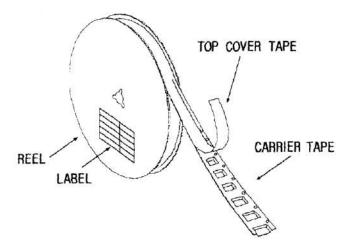
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shall be packed properly not to be damaged during transportation and storage.

#### 7.2 Reeling Quantity

1000 pcs/reel 7" 3000 pcs/reel 13"

#### 7.3 Taping Structure

(1) The tape shall be wound around the reel in the direction shown below.

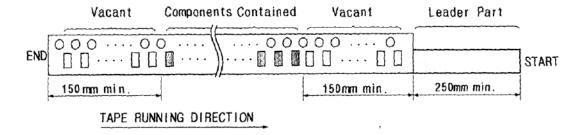


#### **SAW RESONATOR**

(2) Label

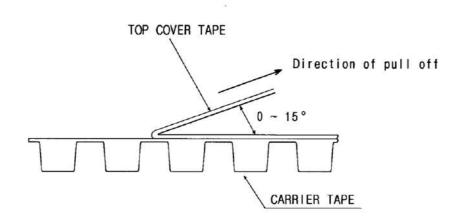
Device Name	
User Product Name	
Quantity	
Lot No.	

(3) Leader part and vacant position specifications.



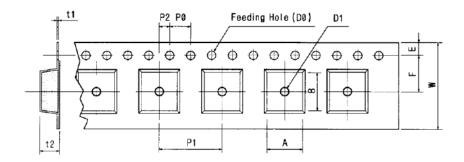
#### 8. TAPE SPECIFICATIONS

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
  - (1) pull off angle: 0~15°
    (2) speed: 300mm/min.
    (3) force: 20~70g



## SAW RESONATOR

[Figure 1] Carrier Tape Dimensions

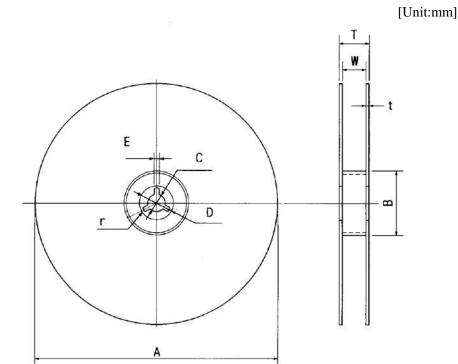


Tape Running Direction

[Unit:mm]

W	F	E	P0	P1	P2	D0	D1	t1	t2	A	В
12.0	5.5	1.75	4.0	8.0	2.0	Ø1.5	Ø1.0	0.3	2.10	6.40	5.20
$\pm 0.3$	$\pm 0.05$	$\pm 0.1$	$\pm 0.1$	$\pm 0.1$	$\pm 0.05$	$\pm 0.1$	$\pm 0.25$	$\pm 0.05$	$\pm 0.1$	$\pm 0.1$	$\pm 0.1$

[Figure 2]



1	A	В	С	D	Е	W	t	r
Ø3	30	Ø100	Ø13	021	2	13	3	1.0
土	1.0	$\pm 0.5$	$\pm 0.5$	$\pm 0.8$	$\pm 0.5$	$\pm 0.3$	max.	max.